

H7N0311LD, H7N0311LS, H7N0311LM

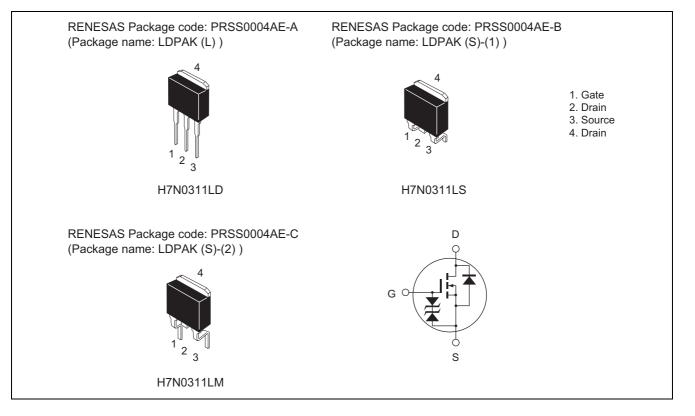
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1126-0500 (Previous: ADE-208-1423C) Rev.5.00 Apr 07, 2006

Features

- Low on-resistance $R_{DS (on)} = 7.0 \text{ m}\Omega \text{ typ.}$
- Low drive current

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	45	А
Drain peak current	I _{D (pulse)} Note 1	180	А
Body to drain diode reverse drain current	I _{DR}	45	А
Channel dissipation	Pch Note 2	60	W
Channel to case thermal impedance	θ ch-c	2.08	°C/W
Channel temperature	Tch	150	٥°
Storage temperature	Tstg	-55 to +150	۵°
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Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25° C

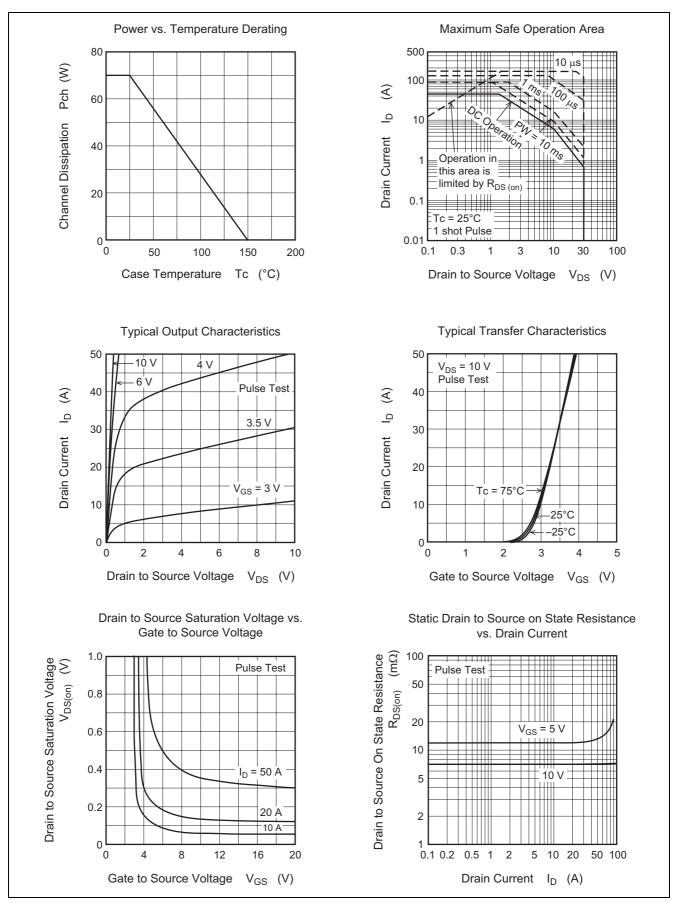
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	30		_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	_	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	_	10	μA	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	1.0		2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note 3}}$
Static drain to source on state	R _{DS (on)}	—	7.0	8.8	mΩ	$I_D = 22.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note 3}$
resistance		—	11	16	mΩ	$I_D = 22.5 \text{ A}, V_{GS} = 5 \text{ V}^{\text{Note 3}}$
Forward transfer admittance	y _{fs}	27	45	—	S	$I_D = 22.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note 3}$
Input capacitance	Ciss	—	1650	—	pF	V _{DS} = 10 V
Output capacitance	Coss	—	440	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	250	—	pF	f = 1 MHz
Total gate charge	Qg	—	28	—	nC	V _{DD} = 10 V
Gate to source charge	Qgs	—	6.0	—	nC	V _{GS} = 10 V
Gate to drain charge	Qgd	—	5.4	—	nC	I _D = 45 A
Turn-on delay time	t _{d (on)}	—	22	—	ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22.5 \text{ A}$
Rise time	tr	—	310	—	ns	$R_L = 0.44 \ \Omega$
Turn-off delay time	t _{d (off)}	—	50	—	ns	Rg = 4.7 Ω
Fall time	t _f	—	16	—	ns	
Body to drain diode forward voltage	V _{DF}	—	0.93	_	V	$I_F = 45 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery	t _{rr}	—	40	_	ns	$I_F = 45 \text{ A}, V_{GS} = 0$
time						di _F /dt = 50 A/µs

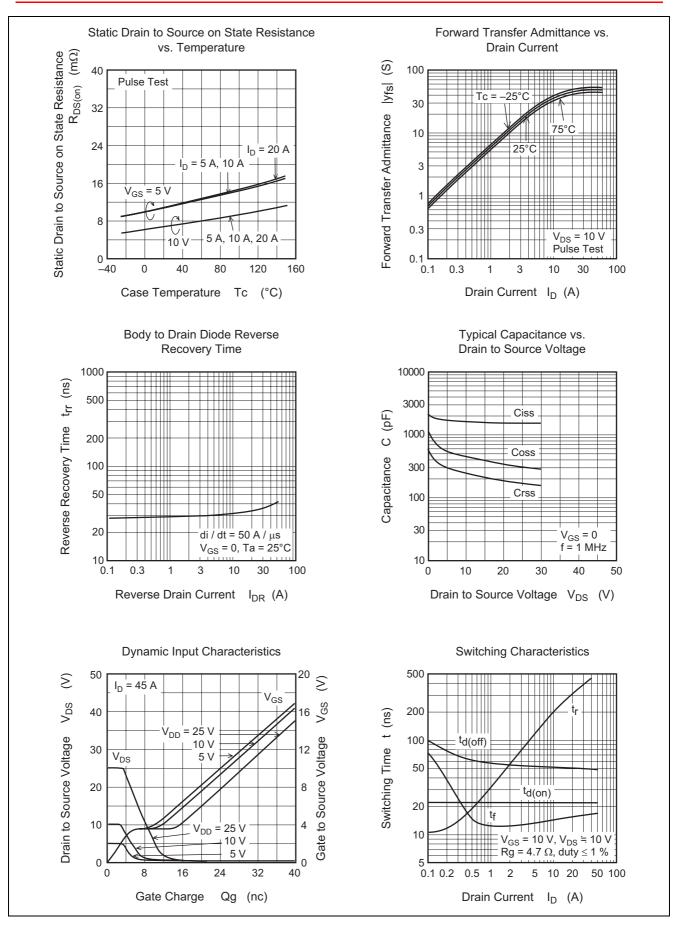
Note: 3. Pulse test



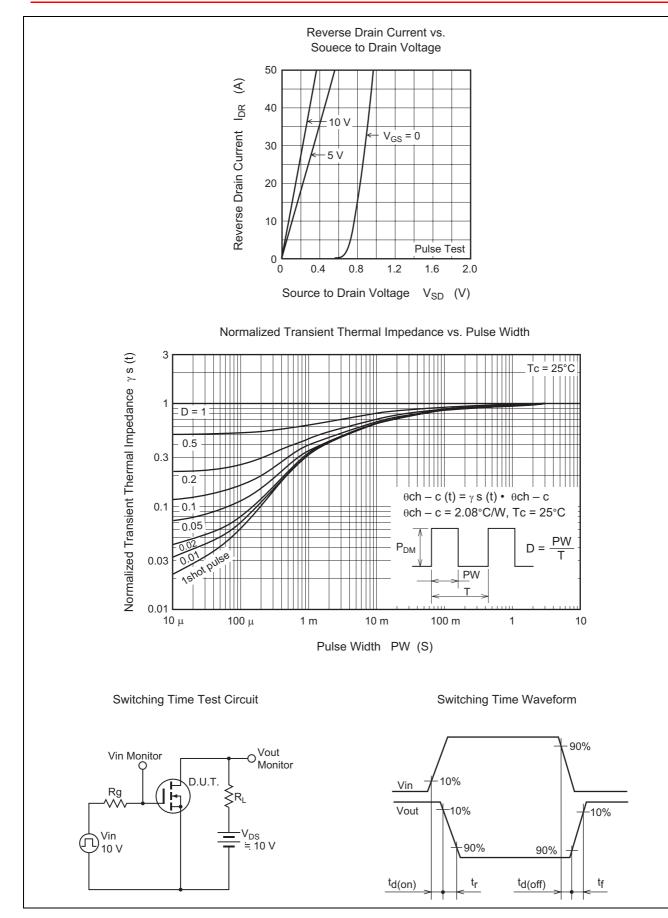
Main Characteristics





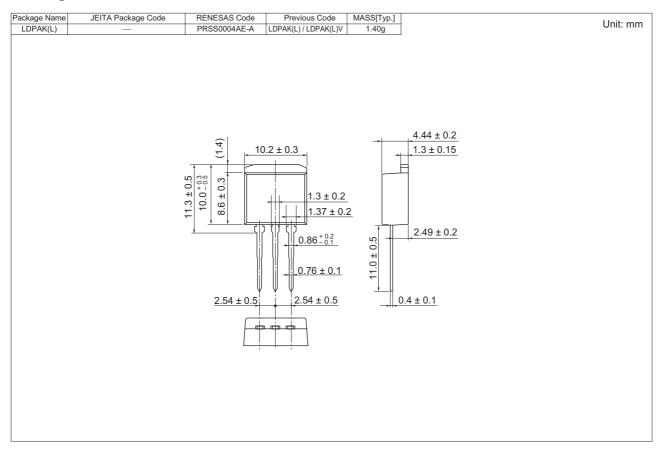


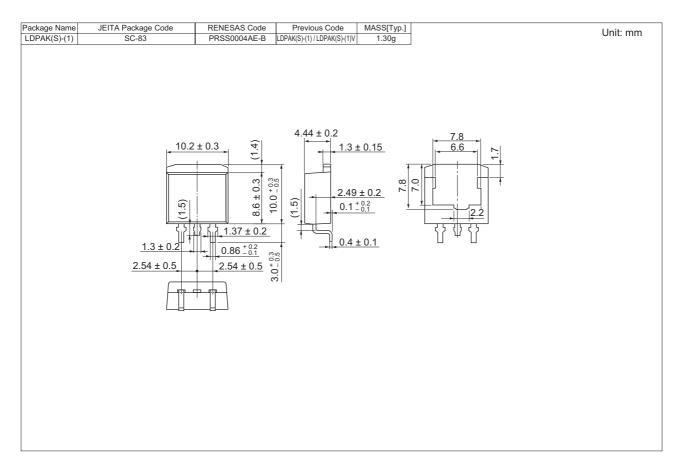






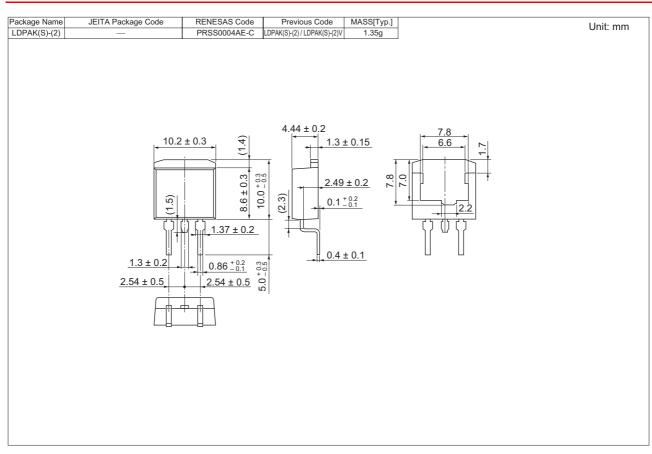
Package Dimensions







H7N0311LD, H7N0311LS, H7N0311LM



Ordering Information

Part Name	Quantity	Shipping Container
H7N0311LD-E	500 pcs	Box (Conductive Sack)
H7N0311LSTL-E	1000 pcs	Taping
H7N0311LMTL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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